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1. A packaged photosensitive element, comprising:

a photosensitive element, having electrical connections; and

a clear plastic package, having said
photosensitive element mounted therein, and providing
a perimeter connected to said electrical connections
on said photosensitive element, said clear plastic
package being clear at all locations within said
perimeter.

- 2. An element as in claim 1, wherein said photosensitive element is a CMOS active pixel sensor.
- 3. An element as in claim 1, wherein said plastic package is acrylic.

4. A method of packaging an image sensor, comprising:

obtaining an image sensor with electrical connections;

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forming a clear plastic package for said image sensor, with said image sensor totally encased within said clear plastic package;

connecting said electrical connections of said image sensor to corresponding connections on a perimeter of said image sensor; and

operating said image sensor to receive light that passes through said clear plastic package.

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